

DIM1800ESS12-A000

Single Switch IGBT Module

Replaces DS5857-1.1

DS5857-2 October 2010 (LN27614)

FEATURES

- 10µs Short Circuit Withstand
- Non Punch Through Silicon
- Isolated Cu Base with Al₂O₃ Substrates
- Lead Free construction

APPLICATIONS

- Motor Controllers
- Traction Drives

The Powerline range of high power modules includes half bridge, chopper, dual, single and bi-directional switch configurations covering voltages from 1200V to 6500V and currents up to 2400A.

The DIM1800ESS12-A000 is a single switch 1200V, n-channel enhancement mode, insulated gate bipolar transistor (IGBT) module. The IGBT has a wide reverse bias safe operating area (RBSOA) plus 10µs short circuit withstand. This device is optimised for traction drives and other applications requiring high thermal cycling capability.

The module incorporates an electrically isolated base plate and low inductance construction enabling circuit designers to optimise circuit layouts and utilise grounded heat sinks for safety.

ORDERING INFORMATION

Order As:

DIM1800ESS12-A000

Note: When ordering, please use the complete part number

KEY PARAMETERS

V_{CES}		1200V
V _{CE(sat)}	* (typ)	2.2V
I _C	(max)	1800A
I _{C(PK)}	(max)	3600A

^{*} Measured at the power busbars, not the auxiliary terminals

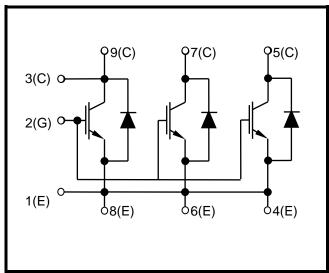


Fig. 1 Circuit configuration



Fig. 2 Package



ABSOLUTE MAXIMUM RATINGS

Stresses above those listed under 'Absolute Maximum Ratings' may cause permanent damage to the device. In extreme conditions, as with all semiconductors, this may include potentially hazardous rupture of the package. Appropriate safety precautions should always be followed. Exposure to Absolute Maximum Ratings may affect device reliability.

T_{case} = 25°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
V _{CES}	Collector-emitter voltage	V _{GE} = 0V	1200	V
V_{GES}	Gate-emitter voltage		±20	V
I _C	Continuous collector current	T _{case} = 85°C	1800	Α
I _{C(PK)}	Peak collector current	1ms, T _{case} = 115°C	3600	Α
P _{max}	Max. transistor power dissipation	$T_{case} = 25^{\circ}C, T_{j} = 150^{\circ}C$	15625	W
l ² t	Diode I ² t value	$V_R = 0$, $t_p = 10$ ms, $T_j = 125$ °C	900	kA ² s
V _{isol}	Isolation voltage – per module	Commoned terminals to base plate. AC RMS, 1 min, 50Hz	2500	V

THERMAL AND MECHANICAL RATINGS

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Units
R _{th(j-c)}	Thermal resistance – transistor	Continuous dissipation - junction to case	-	-	8	°C/kW
R _{th(j-c)}	Thermal resistance – diode	Continuous dissipation - junction to case	ı	-	13	°C/kW
R _{th(c-h)}	Thermal resistance – case to heatsink (per module)	Mounting torque 5Nm (with mounting grease)	ı	-	6	°C/kW
_	Junction temperature	Transistor	-	-	150	°C
T _j		Diode	-	-	125	°C
T _{stg}	Storage temperature range	-	-40	-	125	°C
		Mounting – M6	ı	ı	5	Nm
	Screw torque	Electrical connections – M4	-	-	2	Nm
		Electrical connections – M8	-	-	10	Nm



ELECTRICAL CHARACTERISTICS

 T_{case} = 25°C unless stated otherwise.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
,	Collector cut-off current	$V_{GE} = 0V$, $V_{CE} = V_{CES}$			3	mA
I _{CES}		$V_{GE} = 0V$, $V_{CE} = V_{CES}$, $T_{case} = 125$ °C			75	mA
I _{GES}	Gate leakage current	$V_{GE} = \pm 20V, V_{CE} = 0V$			12	μΑ
V _{GE(TH)}	Gate threshold voltage	$I_C = 90$ mA, $V_{GE} = V_{CE}$	4.5	5.5	6.5	V
\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	Collector-emitter saturation voltage	V _{GE} = 15V, I _C = 1800A		2.2	2.8	V
V _{CE(sat)} †		V _{GE} = 15V, I _C = 1800A, T _j = 125°C		2.6	3.3	V
I _F	Diode forward current	DC			1800	Α
I _{FM}	Diode maximum forward current	t _p = 1ms			3600	Α
v, t	Diode forward voltage	I _F = 1800A		1.9	2.1	V
V _F [†]		I _F = 1800A, T _j = 125°C		1.8	2.1	V
C _{ies}	Input capacitance	$V_{CE} = 25V, V_{GE} = 0V, f = 1MHz$		200		nF
Qg	Gate charge	±15V		20		μC
C _{res}	Reverse transfer capacitance	$V_{CE} = 25V, V_{GE} = 0V, f = 1MHz$				nF
L _M	Module inductance			10		nΗ
R _{INT}	Internal transistor resistance			90		μΩ
SC _{Data}	Short circuit current, I _{SC}	$T_{j} = 125^{\circ}\text{C}, V_{CC} = 900\text{V}$ $t_{p} \le 10\mu\text{s}, V_{GE} \le 15\text{V}$ $V_{CE (max)} = V_{CES} - L^{*}x dI/dt$ IEC 60747-9		10000		А

 $^{^{\}dagger}$ Measured at the power busbars, not the auxiliary terminals * L is the circuit inductance + $L_{\rm M}$



ELECTRICAL CHARACTERISTICS

T_{case} = 25°C unless stated otherwise

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Units
t _{d(off)}	Turn-off delay time	$I_{C} = 1800A$ $V_{GF} = \pm 15V$		1250		ns
t _f	Fall time			190		ns
E _{OFF}	Turn-off energy loss	$V_{CE} = 600V$		330		mJ
t _{d(on)}	Turn-on delay time	$R_{G(ON)} = 1.2\Omega$ $R_{G(OFF)} = 1.2\Omega$ $L_S \sim 60 \text{nH}$		220		ns
t _r	Rise time			200		ns
E _{ON}	Turn-on energy loss			100		mJ
Q_{rr}	Diode reverse recovery charge	I _F = 1800A		210		μC
I _{rr}	Diode reverse recovery current	V _{CE} = 600V		860		Α
E _{rec}	Diode reverse recovery energy	$dI_F/dt = 9000A/\mu s$		110		mJ

T_{case} = 125°C unless stated otherwise

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Units
$t_{d(off)}$	Turn-off delay time			1450		ns
t _f	Fall time	$I_{C} = 1200A$ $V_{GF} = \pm 15V$		190		ns
E _{OFF}	Turn-off energy loss	$V_{CE} = 600V$		390		mJ
t _{d(on)}	Turn-on delay time	$R_{G(ON)} = 1.2\Omega$ $R_{G(OFF)} = 1.2\Omega$ $L_S \sim 60 \text{nH}$		230		ns
t _r	Rise time			340		ns
E _{ON}	Turn-on energy loss			180		mJ
Q _{rr}	Diode reverse recovery charge	$I_F = 1800A$ $V_{CE} = 600V$ $dI_F/dt = 8000A/\mu s$		390		μC
I _{rr}	Diode reverse recovery current			1100		Α
E _{rec}	Diode reverse recovery energy			200		mJ



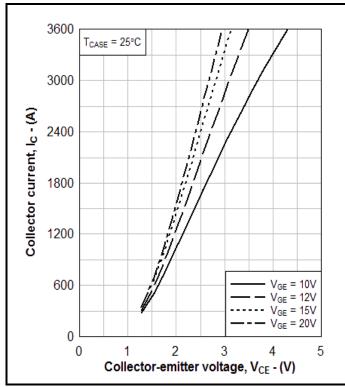


Fig. 3 Typical output characteristics

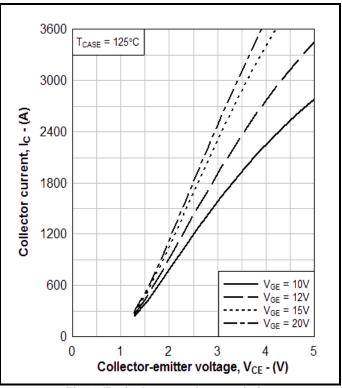


Fig. 4 Typical output characteristics

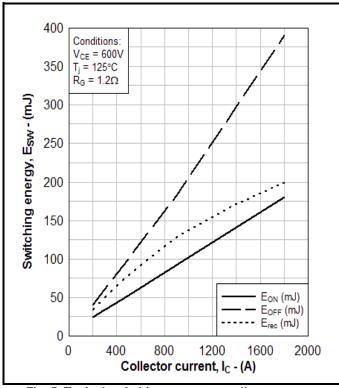


Fig. 5 Typical switching energy vs collector current

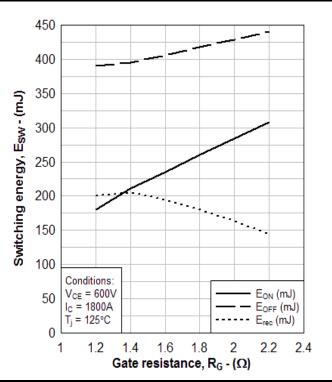


Fig. 6 Typical switching energy vs gate resistance



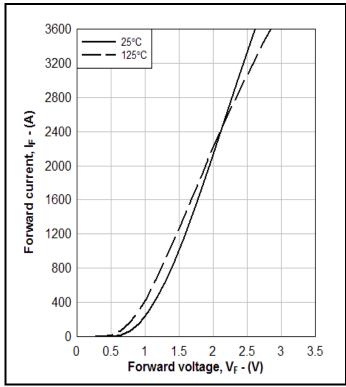


Fig. 7 Diode typical forward characteristics

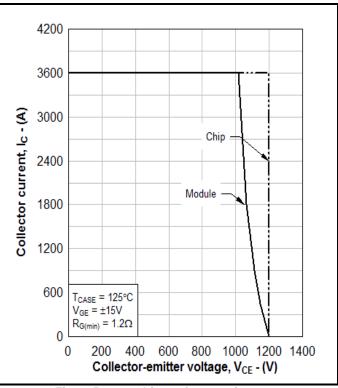


Fig. 8 Reverse bias safe operating area

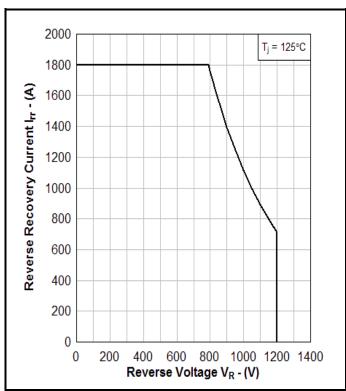


Fig. 9 Diode reverse bias safe operating area

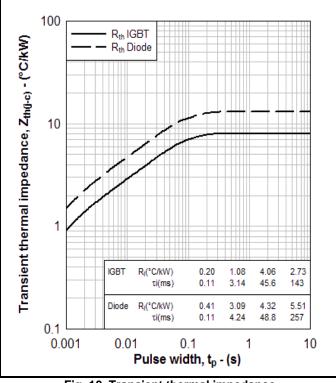


Fig. 10 Transient thermal impedance



PACKAGE DETAILS

For further package information, please visit our website or contact Customer Services. All dimensions in mm, unless stated otherwise.

DO NOT SCALE.

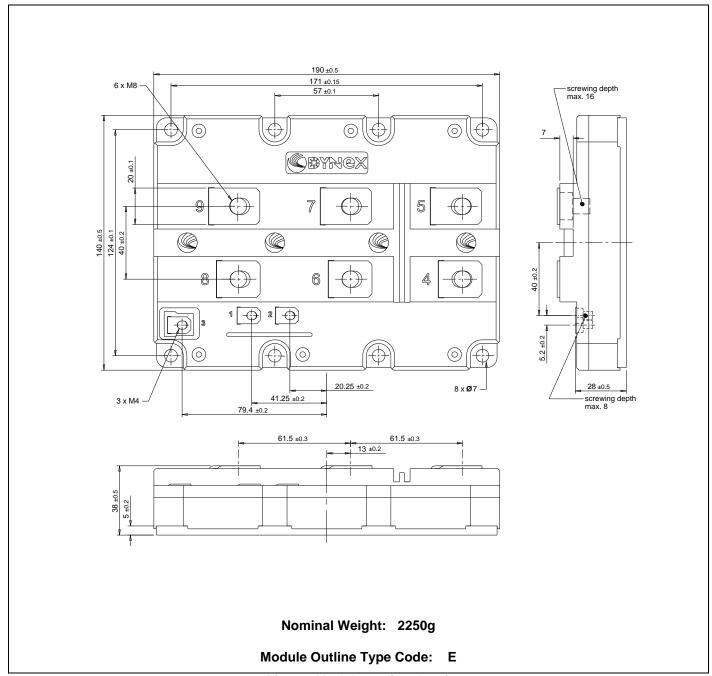


Fig. 11 Module outline drawing



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